### **Description**

The BP2831A is a high precision buck constant current LED driver. The device operates in critical conduction mode and is suitable for 85Vac~265Vac universal input offline LED lighting.

The BP2831A integrates a 500V power MOSFET. With patent pending MOSFET driving technique, the operating current of the IC is very low. S need the auxiliary winding for supplying the chip. It can achieve excellent constant current performance with very few external components, so the system cost and size are minimized.

The BP2831A utilizes patent pending current control method. It can achieve precise output current and excellent line regulation. The driver operates in critical conduction mode, the output current does not change with the inductance and LED output voltage.

The BP2831A offers rich protection functions to improve the system reliability, including LED open circuit protection, LED short circuit protection, VCC under voltage protection, CS resistor short circuit protection and thermal regulation function.

#### **Features**

- Critical Conduction Mode Operation
- Internal 500V Power MOSFET
- No Auxiliary Winding
- Ultra Low Operating Current
- ±5% LED Output Current Accuracy
- LED Open Protection
- LED Short Protection
- Current Sensing Resistor Short Protection
- VCC Under Voltage Protection
- Thermal Regulation Function
- Available in SOP8 Package

### **Applications**

- LED Candle Light
- LED Bulb
- Other LED Lighting

# **Typical Application**

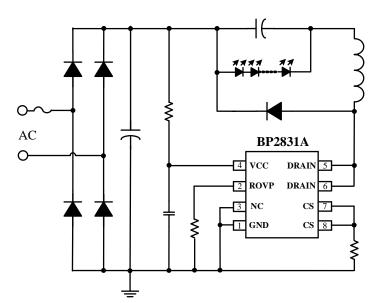


Figure 1. Typical application circuit for BP2831A

# **Ordering Information**

Package	Operating Temperature	Packing Method	Marking
SOP8	-40 °C to 105 °C	Tape 4 000 Piece/Reel	BP2831A XXXXXY WXYY
		Temperature	Tape

# **Pin Configuration and Marking Information**

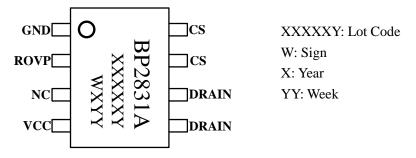


Figure 2. Pin configuration

## **Pin Definition**

Pin No.	Name	Description	
1	GND	Ground	
2	ROVP	Over Voltage Protection Setting Pin. Connect a resistor to GND	
3	NC	No Connection. Should be connected to GND(Pin1)	
4	VCC	Power Supply Pin	
5,6	DRAIN	Internal HV Power MOSFET Drain.	
7,8	CS	Current Sense Pin. Connect a sense resistor between this pin and GND pin.	

## Absolute Maximum Ratings (note1)

Symbol	Parameters	Range	Units	
I <sub>CC_MAX</sub>	VCC pin maximum sink current	5	mA	
DRAIN	Internal HV MOSFET drain voltage	-0.3~500	V	
CS	Current sense pin input voltage	-0.3~6	V	
ROVP	Over-voltage setting pin voltage	-0.3~6	V	
P <sub>DMAX</sub>	Power dissipation (note 2)	0.45	W	
JA	Thermal resistance (Junction to Ambient)	145	°C/W	
$T_{J}$	Operating junction temperature	-40 to 150	$^{\circ}$	
$T_{STG}$	Storage temperature range	-55 to 150	${\mathbb C}$	
	ESD (note 3)	2	KV	

Note 1: erating

ular parameter may not be achieved. The electrical characteristics table defines the operation

range of the device, the electrical characteristics is assured on DC and AC voltage by test program. For the parameters without minimum and maximum value in the EC table, the typical value defines the operation range, the accuracy is not guaranteed by spec.

Note 2: The maximum power dissipation decrease if temperature rise, it is decided by  $T_{JMAX}$   $_{JA}$ , and environment temperature  $(T_A)$ . The maximum power dissipation is the lower one between  $P_{DMAX} = (T_{JMAX} - T_A)$   $_{JA}$  and the number listed in the maximum table.

Note 3: Human Body mode, 100pF capacitor discharge on 1.5K

## **Recommended Operation Conditions**

Symbol	Parameter	Range	Unit	
$I_{LED1}$	Output LED current @ Vout=72V	160	mA	
	(Input voltage 176V~265V)	100		
I <sub>LED2</sub>	Output LED current @ Vout=36V	220	mA	
	(Input voltage 176V~265V)	220		
V <sub>LED min</sub>	Minimum LED Loading Voltage	>15	V	

## Non-isolated Buck Offline LED Driver

# Electrical Characteristics (Notes 4, 5) (Unless otherwise specified, $V_{CC}$ =15V and $T_A$ =25 $^{\circ}$ C)

Parameter	Conditions	Min	Тур	Max	Units
Section					
V <sub>CC</sub> Clamp Voltage	1mA		16.8		V
V <sub>CC</sub> Turn On Threshold	V <sub>CC</sub> Rising		13.8		V
V <sub>CC</sub> Turn off Threshold	V <sub>CC</sub> Falling		9		V
V <sub>CC</sub> Startup Current	$V_{CC} = V_{CC-ON} - 1V$		120	180	uA
V <sub>CC</sub> Operating Current	F <sub>OP</sub> =70KHz		100	150	uA
ection					
Threshold Voltage for Peak Current Limit		388	400	412	mV
Threshold Voltage for Peak Current Limit When Output Short	Output Short		200		mV
Leading Edge Blanking Time for Current Sense			350		ns
Switch Off Delay Time			200		ns
ontrol Section					
Minimum OFF Time			4.5		us
Maximum OFF Time			240		us
Maximum On Time			40		us
ROVP Pin Voltage			0.5		V
on					
Static Drain-source On-resistance	V <sub>GS</sub> =15V/I <sub>DS</sub> =0.4A		14		
Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V/I <sub>DS</sub> =250uA	500			V
Power MOSFET Drain Leakage Current	V <sub>GS</sub> =0V/V <sub>DS</sub> =500V			1	uA
Thermal Regulation Section					
Thermal Regulation Temperature			150		${\mathbb C}$
	Vcc Clamp Voltage Vcc Turn On Threshold Vcc Turn off Threshold Vcc Startup Current Vcc Operating Current ection Threshold Voltage for Peak Current Limit Threshold Voltage for Peak Current Limit When Output Short Leading Edge Blanking Time for Current Sense Switch Off Delay Time ontrol Section Minimum OFF Time Maximum OFF Time Maximum On Time ROVP Pin Voltage on Static Drain-source On-resistance Drain-Source Breakdown Voltage Power MOSFET Drain Leakage Current tion Section Thermal Regulation	Vcc Clamp Voltage  Vcc Turn On Threshold  Vcc Turn off Threshold  Vcc Turn off Threshold  Vcc Startup Current  Vcc Operating Current  Vcc Operating Current  Threshold Voltage for Peak Current Limit  Threshold Voltage for Peak Current Limit When Output Short  Leading Edge Blanking Time for Current Sense Switch Off Delay Time  Ontrol Section  Minimum OFF Time Maximum OFF Time Maximum On Time ROVP Pin Voltage  Threshold Voltage  Power MOSFET Drain Leakage Current  Thermal Regulation  Ima  Vcc Rising Vcc Rising Vcc Falling Vcc Pcc-vc-on-1V Vcc Pcc-vcc-on-1V Vcc Pcc-vcc-on-1V Vcc Pcc Pcc Falling Vcc Falling Vcc Falling Vcc Pcc Vcc-on-1V FoP-70KHz	Section  Vcc Clamp Voltage Vcc Turn On Threshold Vcc Rising Vcc Turn off Threshold Vcc Startup Current Vcc Operating Current Vcc Operating Current Threshold Voltage for Peak Current Limit Threshold Voltage for Peak Current Limit When Output Short Leading Edge Blanking Time for Current Sense Switch Off Delay Time Ontrol Section  Minimum OFF Time Maximum OFF Time Maximum OrF Time ROVP Pin Voltage In Static Drain-source On-resistance Drain-Source Breakdown Voltage Power MOSFET Drain Leakage Current Thermal Regulation  Thermal Regulation	Name	Section   V <sub>CC</sub> Clamp Voltage   1mA   16.8   13.8   V <sub>CC</sub> Turn On Threshold   V <sub>CC</sub> Rising   13.8   V <sub>CC</sub> Turn off Threshold   V <sub>CC</sub> Falling   9   V <sub>CC</sub> Startup Current   V <sub>CC</sub> V <sub>CC-ON</sub> -1V   120   180   V <sub>CC</sub> Operating Current   F <sub>OP</sub> =70KHz   100   150   150   ection

Note 4: production testing of the chip is performed at 25 °C.

Note 5: the maximum and minimum parameters specified are guaranteed by test, the typical value are guaranteed by design, characterization and statistical analysis

### **Internal Block Diagram**

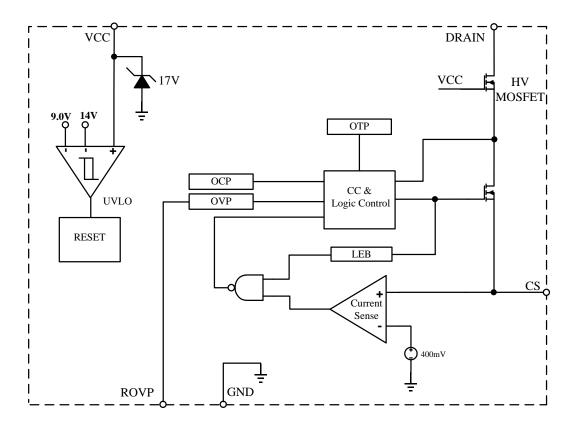


Figure 3. BP2831A Internal Block Diagram

### **Application Information**

The BP2831A is a high performance non-isolated Buck converter specially designed for LED lighting. The device integrates a 500V power MOSFET. With very few external components, the converter achieves excellent constant current control. And it does not need auxiliary winding for powering the IC or voltage sensing, hence the system size and cost is greatly reduced.

#### Start Up

After system powered up, the VCC pin capacitor is charged up by the start up resistor. When the VCC pin voltage reaches the turn on threshold, the internal circuits start operating. The BP2831A integrates a 17V zener diode to clamp the VCC voltage. Due to the ultra-low operating current, the auxiliary winding is not needed to supply the IC.

#### **Constant Current Control**

Cycle by Cycle current sense is adopted in BP2831A, the CS pin is connected to the current sense comparator, and the voltage on CS pin is compared with the internal 400mV reference voltage. The MOSFET will be switched off when the voltage on CS pin reaches the threshold. The CS comparator includes a 350ns leading edge blanking time.

The peak inductor current is given by:

$$I_{PK} = \frac{400}{R_{CS}} (mA)$$

Where, R<sub>CS</sub> is the current sense resistor value.

The current in LED can be calculated by the equation:

### Non-isolated Buck Offline LED Driver

$$I_{LED} = \frac{I_{PK}}{2}$$

Where, I<sub>PK</sub> is the peak current of the inductor.

#### **Inductor Selection**

The BP2831A works under inductor current critical conduction mode. When the power MOFET is switched on, the current in the inductor rises up from zero, the on time of the MOSFET can be calculated by the equation:

$$t_{\rm on} = \frac{L \times I_{\rm PK}}{V_{\rm IN} - V_{\rm LED}}$$

Where.

L is the inductance value

 $V_{\text{IN}}$  is the DC bus voltage after the rectifier bridge  $V_{\text{LED}}$  is the voltage on the LED

After the power MOSFET is switched off, the current in the inductor decreases. When the inductor current reaches zero, the power MOSFET is turned on again by IC internal logic. The off time of the MOSFET is given by:

$$t_{\text{off}} = \frac{L \times I_{PK}}{V_{LED}}$$

The inductance can be calculated by the equation:

$$L = \frac{V_{\text{LED}} \times (V_{\text{IN}} - V_{\text{LED}})}{f \times I_{\text{PK}} \times V_{\text{IN}}}$$

The f is the system switching frequency, which is proportional to the input voltage. So the minimum switching frequency is set at lowest input voltage, and the maximum switching frequency is set at highest input voltage.

The minimum and maximum off time of BP2831A is set at 4.5us and 240us, respectively. Referring to the equation of  $t_{OFF}$  calculation, if the inductance is too

small, the  $t_{OFF}$  may be smaller than the minimum off time, system will operate in discontinuous conduction mode and the output current will be smaller than the designed value. If the inductance is too large, the  $t_{OFF}$  may be larger than the maximum off time, the system will operate in continuous conduction mode and the output current will be higher than the designed value. So it is important to choose a proper inductance.

#### **Over Voltage Protection**

The over voltage protection can be programmed by the ROVP pin resistor. The ROVP pin voltage is 0.5V.

When the LED is open circuit, the output voltage increases gradually, and the demagnetization time gets shorter. The demagnetization time at OVP----Tovp can be calculated by the open circuit protection voltage:

$$Tovp \approx \frac{L \times Vcs}{Rcs \times Vovp}$$

Where,

Vcs is the CS pin turn off threshold (400mV) Vovp is the open circuit protection voltage

And then the Rovp resistor value can be calculated by the equation:

$$Rovp \approx 15 * Tovp * 10^6$$
 (kohm)

#### **Protection Function**

The BP2831A offers rich protection functions to improve the system reliability, including LED open/short protection, CS resistor short protection,  $V_{\rm CC}$  under voltage protection, thermal regulation. When the LED is open circuit, the system will trigger the over voltage protection and stop switching.

When the LED short circuit is detected, the system works at low frequency (5kHz), and the CS pin turn

#### Non-isolated Buck Offline LED Driver

off threshold is reduced to 200mV. So the system power consumption is very low. At some catastrophic fault condition, such as CS resistor shorted or inductor saturated, the internal fast fault detection circuit will be triggered, the system stops switching immediately.

After the system enters into fault condition, the VCC voltage will decrease until it reaches the UVLO threshold, then the system will re-start again. If the fault condition is removed, the system will recover to normal operation.

#### **Thermal Regulation**

The BP2831A integrates thermal regulation function. When the system is over temperature, the output current is gradually reduced; the output power and thermal dissipation are also reduced. The system temperature is regulated and the system reliability is improved. The thermal regulation temperature is set to 150°C internally.

#### **PCB** Layout

The following rules should be followed in BP2831A PCB layout:

**Bypass Capacitor** 

The bypass capacitor on  $V_{CC}$  pin should be as close as possible to the  $V_{CC}$  Pin and GND pin.

**ROVP Pin** 

The ROVP resistor should be as close as possible to the ROVP Pin.

Ground Path

The power ground path for current sense should be short, and the power ground path should be separated from small signal ground path before connecting to the negative node of the bulk capacitor.

The Area of Power Loop

The area of main current loop should be as small as possible to reduce EMI radiation, such as the inductor, the power MOSFET, the output diode and

the bus capacitor loop.

NC pin

The NC pin should be connected to GND (pin1).

Drain Pin

To increase the copper area of DRAIN pin for better thermal dissipation. However too large copper area may compromise EMI performance.

## **Physical Dimensions**

